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INTERNATIONAL STANDARD

**Ferrite cores - Guidelines on dimensions and the limits of surface irregularities -
Part 4: RM-cores**

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IEC 63093-4 has been prepared by IEC technical committee 51: Magnetic components, ferrite and magnetic powder materials. It is an International Standard.

This second edition cancels and replaces the first edition published in 2019. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) revision of Table 3 and Table 4 according to IEC 60205 ED4.

The text of this International Standard is based on the following documents:

Draft	Report on voting
51/1586/FDIS	51/1599/RVD

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/publications.

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The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under webstore.iec.ch in the data related to the specific document. At this date, the document will be

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